# 10V Drive Nch MOS FET RDX080N50

#### Structure

Silicon N-channel MOS FET

### Features

- 1) Low on-resistance.
- 2) Low input capacitance.
- 3) Excellent resistance to damage from static electricity.

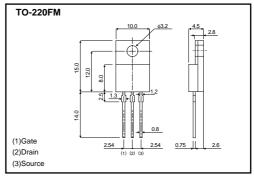
#### Applications

Switching

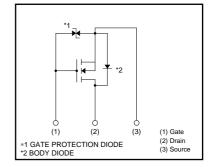
#### Packaging specifications

|           | Package                      | Bulk |  |  |
|-----------|------------------------------|------|--|--|
| Туре      | Code                         | _    |  |  |
|           | Basic ordering unit (pieces) | 500  |  |  |
| RDX080N50 |                              | 0    |  |  |

#### •External dimensions (Unit : mm)



#### Inner circuit



#### Absolute maximum ratings (Ta=25°C)

| Parameter                      |            | Symbo | ol | Limits      | Unit |
|--------------------------------|------------|-------|----|-------------|------|
| Drain-source voltage           |            | VDSS  |    | 500         | V    |
| Gate-source voltage            |            | Vgss  |    | ±30         | V    |
| Drain current                  | Continuous | ID    | *1 | ±8          | A    |
|                                | Pulsed     | IDP   | *2 | ±32         | A    |
| Source current                 | Continuous | ls    |    | 8           | A    |
| (Body diode)                   | Pulsed     | Isp   | *2 | 32          | A    |
| Avalanche current              |            | las   | *3 | 8           | A    |
| Avalanche energy               |            | Eas   | *4 | 85          | mJ   |
| Total power dissipation (Tc=25 | °C)        | PD    |    | 40          | W    |
| Channel temperature            |            | Tch   |    | 150         | °C   |
| Range of storage temperature   |            | Tstg  |    | -55 to +150 | °C   |
|                                |            |       |    |             |      |

\*1 Limited only by maximum temperature allowed \*2 Pw ≤10μs, Duty cycle ≤ 1% \*3 L ≒ 2.3mH Vob=90V Rg=25Ω \*4 L ≒ 2.3mH Vob=90V Rg=25Ω starting Tch=25°C

#### Thermal resistance

| Parameter       | Symbol    | Limits | Unit |
|-----------------|-----------|--------|------|
| Channel to case | Rth(ch-c) | 3.125  | °C/W |

## Transistors

## ●Electrical characteristics (Ta=25°C)

| Parameter                               | Symbol                | Min. | Тур. | Max. | Unit | Conditions                                  |
|---|-----------------------|------|------|------|------|---|
| Gate-source leakage                     | Igss                  | -    | -    | ±10  | μΑ   | $V_{GS}=\pm 25V, V_{DS}=0V$                 |
| Drain-source breakdown voltage          | V(BR) DSS             | 500  | -    | _    | V    | I <sub>D</sub> = 1mA, V <sub>GS</sub> =0V   |
| Zero gate voltage drain current         | IDSS                  | -    | -    | 25   | μΑ   | V <sub>DS</sub> = 500V, V <sub>GS</sub> =0V |
| Gate threshold voltage                  | V <sub>GS (th)</sub>  | 2.0  | -    | 4.0  | V    | V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA |
| Static drain-source on-state resistance | $R_{DS(on)}^*$        | _    | 0.65 | 0.85 | Ω    | I <sub>D</sub> = 4A, V <sub>GS</sub> = 10V  |
| Forward transfer admittance             | Y <sub>fs</sub> *     | 3    | 5    | _    | S    | V <sub>DS</sub> = 10V, I <sub>D</sub> = 4A  |
| Input capacitance                       | Ciss                  | -    | 920  | _    | pF   | V <sub>DS</sub> = 25V                       |
| Output capacitance                      | Coss                  | -    | 125  | _    | pF   | V <sub>GS</sub> =0V                         |
| Reverse transfer capacitance            | Crss                  | -    | 27   | _    | pF   | f=1MHz                                      |
| Turn-on delay time                      | t <sub>d (on)</sub> * | -    | 20   | _    | ns   | Vdd≒ 150V                                   |
| Rise time                               | tr *                  | -    | 22   | _    | ns   | D = 4A                                      |
| Turn-off delay time                     | td (off) *            | -    | 55   | _    | ns   | Vgs= 10V<br>R∟= 37.5Ω                       |
| Fall time                               | t <sub>f</sub> *      | -    | 30   | _    | ns   | R <sub>G</sub> =10Ω                         |
| Total gate charge                       | Qg *                  | _    | 28   | -    | nC   | Vpp≒250V, Vgs=10V                           |
| Gate-source charge                      | Q <sub>gs</sub> *     | _    | 6.5  | -    | nC   | ID=8A                                       |
| Gate-drain charge                       | Q <sub>gd</sub> *     | -    | 12   | -    | nC   | $R_L=31.3\Omega$ , $R_G=10\Omega$           |

\*Pulsed

## •Body diode characteristics (Source-drain) (Ta=25°C)

| Parameter               | Symbol | Min. | Тур. | Max. | Unit | Conditions                                |
|-------------------------|--------|------|------|------|------|---|
| Forward voltage         | Vsd *  | -    | -    | 1.5  | V    | Is= 8A, V <sub>GS</sub> =0V               |
| Reverse recovery time   | trr    | -    | 375  | -    | ns   | I <sub>DR</sub> = 8A, V <sub>GS</sub> =0V |
| Reverse recovery charge | Qrr    | _    | 2.5  | -    | μC   | di/dt= 100A / μs                          |

\* Pulsed

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